

ULTRA LOW CAPACITANCE TVS ARRAY
APPLICATIONS

- ✓ Ethernet - 10/100 Base T
- ✓ Cellular Phones
- ✓ FireWire
- ✓ Audio/Video Inputs
- ✓ Portable Electronics

IEC COMPATIBILITY (EN61000-4)

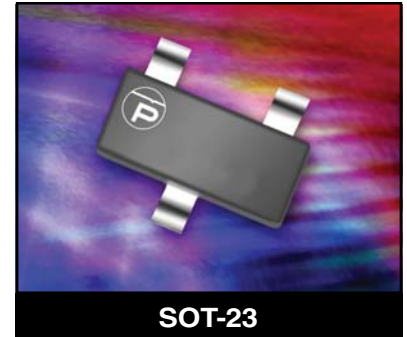
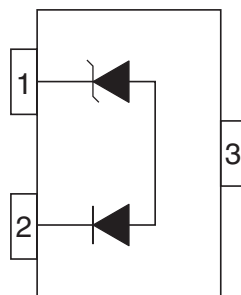
- ✓ 61000-4-2 (ESD): Air - 15kV, Contact - 8kV
- ✓ 61000-4-4 (EFT): 40A - 5/50ns
- ✓ 61000-4-5 (Surge): 12A, 8/20 μ s - Level 1(Line-Gnd) & Level 2(Line-Line)

FEATURES

- ✓ ESD Protection > 40 kilovolts
- ✓ 500 Watts Peak Pulse Power per Line (tp=8/20 μ s)
- ✓ Low Clamping Voltage
- ✓ Available in 3V - 36V
- ✓ Ultra Low Capacitance: 5pF
- ✓ RoHS Compliant

MECHANICAL CHARACTERISTICS

- ✓ Molded JEDEC SOT-23 Package
- ✓ Weight 8 milligrams (Approximate)
- ✓ Available in Lead-Free Pure-Tin Plating(Annealed)
- ✓ Solder Reflow Temperature:
Pure-Tin - Sn, 100: 260-270°C
- ✓ Consult Factory for Leaded Device Availability
- ✓ Flammability Rating UL 94V-0
- ✓ 8mm Tape and Reel Per EIA Standard 481
- ✓ Marking: Marking Code


PIN CONFIGURATION


PSOT03LC thru PSOT36LC

DEVICE CHARACTERISTICS

MAXIMUM RATINGS @ 25°C Unless Otherwise Specified

PARAMETER	SYMBOL	VALUE	UNITS
Peak Pulse Power ($t_p = 8/20\mu\text{s}$) - See Figure 1	P_{PP}	500	Watts
Operating Temperature	T_L	-55 to 150	°C
Storage Temperature	T_{STG}	-55 to 150	°C

ELECTRICAL CHARACTERISTICS PER LINE @ 25°C Unless Otherwise Specified

PART NUMBER (Note 1)	DEVICE MARKING	RATED STAND-OFF VOLTAGE V_{WM} VOLTS	MINIMUM BREAKDOWN VOLTAGE (See Note 2) @ 1mA $V_{(BR)}$ VOLTS	MAXIMUM CLAMPING VOLTAGE (See Fig. 2) @ $I_p = 1A$ V_C VOLTS	MAXIMUM CLAMPING VOLTAGE (See Fig. 2) @ 8/20 μs $V_C @ I_{PP}$	MAXIMUM LEAKAGE CURRENT @ V_{WM} I_b μA	TYPICAL CAPACITANCE 0V @ 1 MHz C pF
PSOT03LC	03L	3.3	4.0	7.0	10.9V @ 43.0A	125	5
PSOT05LC	05L	5.0	6.0	9.8	13.5V @ 42.0A	20	5
PSOT08LC	08L	8.0	8.5	13.4	16.9V @ 34.0A	10	5
PSOT12LC	12L	12.0	13.3	19.0	25.9V @ 21.0A	1	5
PSOT15LC	15L	15.0	16.7	24.0	30.0V @ 17.0A	1	5
PSOT24LC	24L	24.0	26.7	43.0	49.0V @ 12.0A	1	5
PSOT36LC	36L	36.0	40.0	51.0	76.8V @ 9.0A	1	5

Note 1: Positive potential is applied from pin 1 to 2; pin 2 is ground.

Note 2: Do not test or surge from pin 2 to 1. PIV typically greater than 100V for the rectifier diode.

FIGURE 1
PEAK PULSE POWER VS PULSE TIME

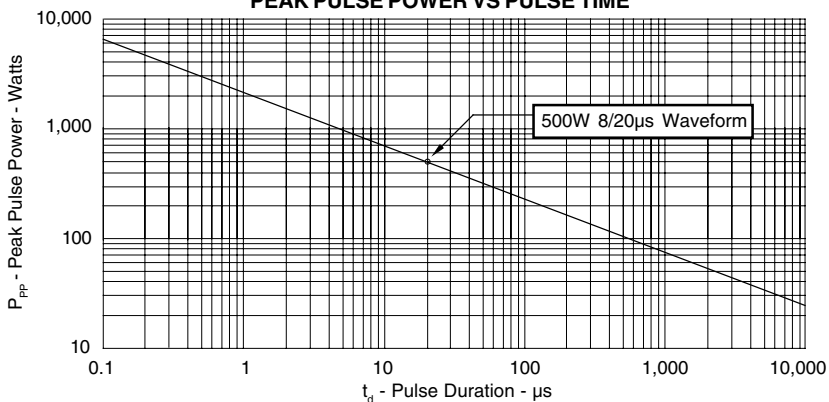
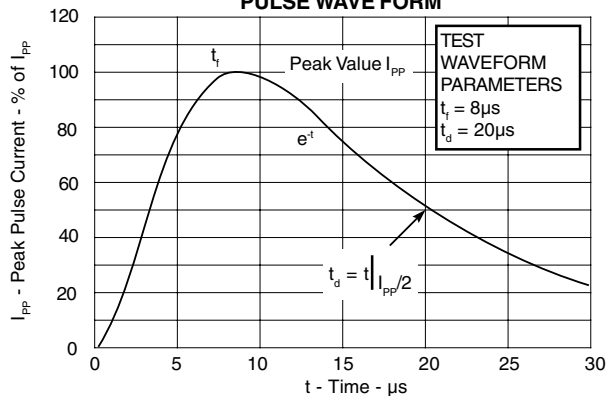
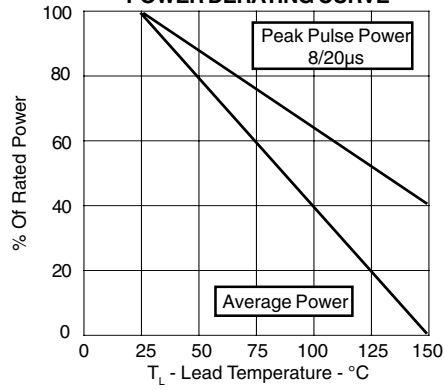


FIGURE 2
PULSE WAVE FORM

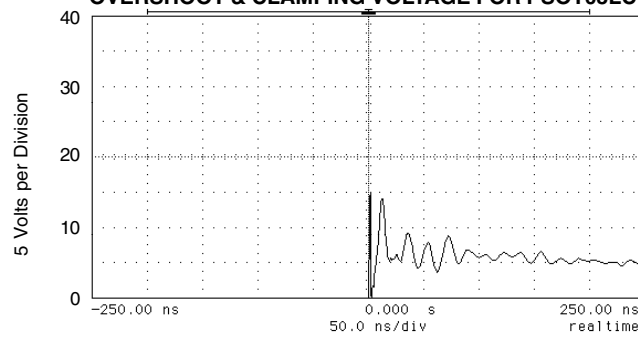


GRAPHS

**FIGURE 3
 POWER DERATING CURVE**

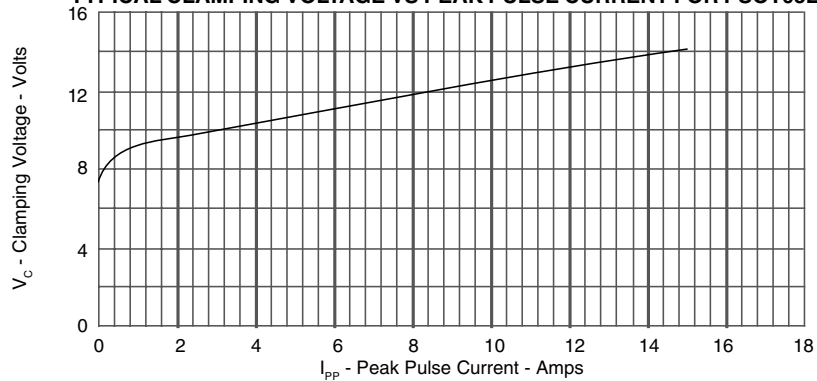


**FIGURE 4
 OVERSHOOT & CLAMPING VOLTAGE FOR PSOT03LC**



ESD Test Pulse: 7 kilovolt, 1/30ns (waveform)

**FIGURE 5
 TYPICAL CLAMPING VOLTAGE VS PEAK PULSE CURRENT FOR PSOT05LC**



APPLICATION NOTE

The PSOTxxLC Series are low capacitance TVS arrays designed to protect I/O or data lines from the damaging effects of ESD or EFT. This product series provides unidirectional & bidirectional protection, with a surge capability of 500 Watts P_{PP} per line for an 8/20 μ s waveform and ESD protection > 40 kilovolts.

BIDIRECTIONAL COMMON-MODE CONFIGURATION (Figure 1)

Two PSOTxxLC devices, when used in parallel, provide protection in a common-mode configuration as depicted in Figure 1.

Circuit connectivity is as follows:

- ✓ I/O Line is connected to Device 1, Pin 1.
- ✓ I/O Line is connect to Device 2, Pin 2.
- ✓ Device 1, Pin 2 is connected to ground.
- ✓ Device 2, Pin 1 is connected to ground.
- ✓ Device 1 & 2, Pin 3 is not connected.

BIDIRECTIONAL DIFFERENTIAL-MODE CONFIGURATION (Figure 1)

In addition, two PSOTxxLC devices, when used in parallel, provide protection in a differential-mode configuration for Ethernet applications as depicted in Figure 2.

Circuit connectivity is as follows:

- ✓ I/O Line 1 is connected to Device 1, Pin 1.
- ✓ I/O Line 1 is connect to Device 2, Pin 2.
- ✓ I/O Line 2 is connected to Device 1, Pin 1.
- ✓ I/O Line 2 is connect to Device 2, Pin 2.
- ✓ Device 1 & 2, Pin 3 is not connected.

CIRCUIT BOARD LAYOUT RECOMMENDATIONS

Circuit board layout is critical for Electromagnetic Compatibility (EMC) protection. The following guidelines are recommended:

- ✓ The protection device should be placed near the input terminals or connectors, the device will divert the transient current immediately before it can be coupled into the nearby traces.
- ✓ The path length between the TVS device and the protected line should be minimized.
- ✓ All conductive loops including power and ground loops should be minimized.
- ✓ The transient current return path to ground should be kept as short as possible to reduce parasitic inductance.
- ✓ Ground planes should be used whenever possible. For multilayer PCBs, use ground vias.

Figure 1 - Common-Mode I/O Port Protection

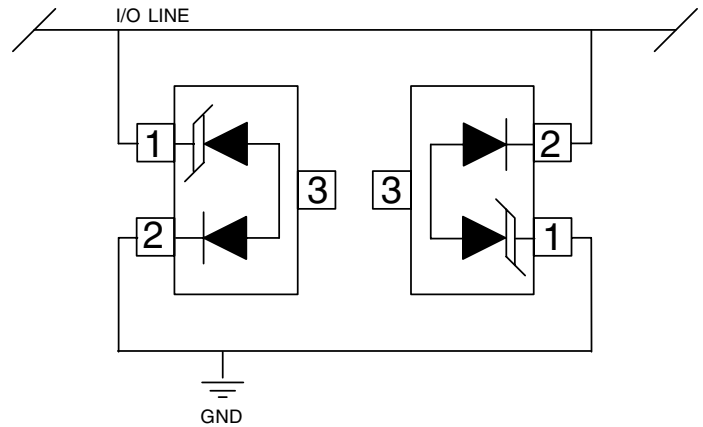
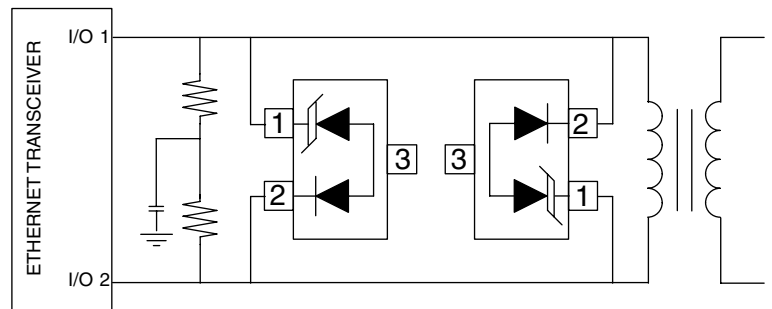


Figure 2 - Differential-Mode Ethernet Protection



PSOT03LC thru PSOT36LC

SOT-23 PACKAGE OUTLINE & DIMENSIONS

PACKAGE OUTLINE		SOT-23			
PACKAGE DIMENSIONS					
DIM	MILLIMETERS		INCHES		
	MIN	MAX	MIN	MAX	
A	2.80	3.04	0.1102	0.1197	
B	1.20	1.40	0.0472	0.0551	
C	0.89	1.11	0.0350	0.0440	
D	0.37	0.50	0.0150	0.0200	
G	1.78	2.04	0.0701	0.0807	
H	0.013	0.100	0.0005	0.0040	
J	0.085	0.177	0.0034	0.0070	
K	0.45	0.60	0.0180	0.0236	
L	0.89	1.02	0.0350	0.0401	
S	2.10	2.50	0.0830	0.0984	
V	0.45	0.60	0.0177	0.0236	
MOUNTING PAD					
NOTES					
<ol style="list-style-type: none"> 1. Dimensioning and tolerances per ANSI Y14.5M, 1985. 2. Controlling Dimension: Inches 3. Pin 3 is the cathode (Unidirectional Only). 4. Dimensions are exclusive of mold flash and metal burrs. 					
TAPE & REEL ORDERING NOMENCLATURE					
<ol style="list-style-type: none"> 1. Surface mount product is taped and reeled in accordance with EIA-481. 2. Suffix-T7 = 7 Inch Reel - 3,000 pieces per 8mm tape, i.e., <i>PSOT05LC-T7</i>. 3. Suffix-T13 = 13 Inch Reel - 10,000 pieces per 8mm tape, i.e., <i>PSOT05LC-T13</i>. 4. Suffix - LF = Lead-Free, Pure-Tin Plating, i.e., <i>PSOT05LC-LF-T7</i>. 					
Outline & Dimensions: Rev 1 - 11/01, 06012					

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